



江苏长晶科技股份有限公司
JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD.

产 品 规 格 书

SPECIFICATIONS FOR PRODUCT

产品类型 TYPE : SMD3225

产品规格 SPEC : 8MHz/3225/12PF/10PPM AEC-Q200

产品型号 P/N : AD-CJ13-080001210D05

日期 DATE : 2022/02/16

核准及签名			部门 DEPT. 频率器件事业部
R&D APPR. SIGNATURED			
拟制 ISSUE	审核 CHECK	批准 APPROVAL	
Ivan 2022/02/16	Abbey 2022/02/16	Ken 2022/02/16	

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SMCE3225 4 pads Crystal Resonator

AD-CJ13-080001210D05

1. Scope:

- 1.1 This specification applies to the RoHS/SONY compliance quartz crystal unit with a frequency of 8MHz which will be used in crystal oscillator applications.
- 1.2 AEC-Q200 qualified

2. Construction:

- 2.1 Type of Quartz Resonator: SMCE3225 4pads

3. Electrical Characteristics

- | | |
|--|---|
| 3.1 Nominal Frequency(f): | 8MHz |
| 3.2 Load Capacitance(C_L): | 12pF |
| 3.3 Frequency Tolerance($\Delta f/f$): | $\pm 10\text{ppm}$ |
| 3.4 Frequency Temperature Stability: | $\pm 100\text{ppm}(\text{Ref.}@25^\circ\text{C})$ |
| 3.5 Resonance Resistance(ohm): | 200ohms Max |
| 3.6 Osc mode: | Fundamental mode |
| 3.7 Shunt Capacitance(C_0): | $< 2\text{pF}$ |
| 3.8 Drive Level(D_L): | $< 100\mu\text{W}$ |
| 3.9 Operating Temperature Range(T_{OPR}): | -40 to + 125 |
| 3.10 Storage Temperature Range(T_{STG}): | -55 to + 125°C |
| 3.11 Insulation Resistance(IR): | $> 500\text{ M ohms}$ |
| 3.12 Aging(Δf_A): | $\pm 3\text{ppm per Year}$ |

4. Reliability Specifications

This is the quality control and quality assurance and reliability tests performance data for the RoHS/

AEC-Q200 compliance 8MHz SMCE3225 4pads crystal resonators

related to the specification and approval sheet provided by JSCJ .

Standard test condition (TEMP.: 20±5°C. Relative humidity: 65±20%)

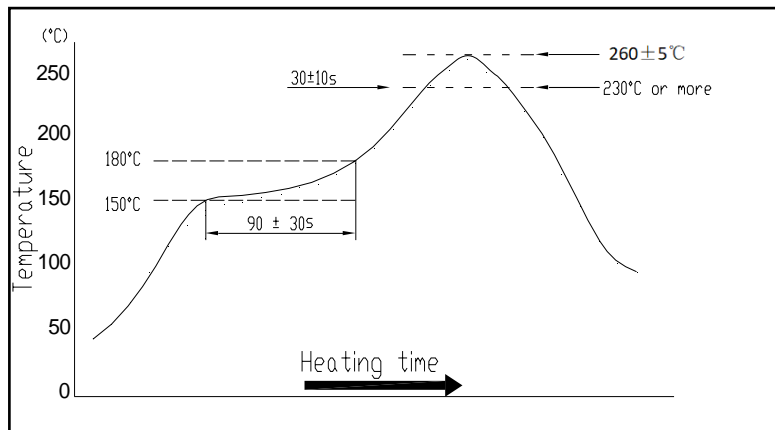
For any discrepancy in GO/NG, test will be done at TEMP.25±2°C, R.H. 65±5%.

NO.	PROCESS	SPECIFICATION	TEST METHOD
4.1	Temperature Cycle	Frequency change after test $\leq \pm 5$ ppm. Resonance resistance change after test ≤ 5 ohms.	1000 cycles from -40°C to 125°C. Measurement taken after DUT being left at room temperature for 24±2 hours.
4.2	High Temperature Storage	Frequency change after test $\leq \pm 5$ ppm. Resonance resistance change after test ≤ 5 ohms.	Spending 1000 hrs at 85°C±3°C constant temperature. Measurement taken after DUT being left at room temperature for 24±2 hours.
4.3	Biased Humidity	Frequency change after test $\leq \pm 5$ ppm. Resonance resistance change after test ≤ 5 ohms.	Spending 1000 hrs at 85 °C ± 3 °C, with 85%R.H. Then keep the DUT in dry oven at 25 ± 5 °C for 24 hour. Measurement taken after DUT being left at room temperature for 1 to 2 hours.
4.4	Operational Life	Frequency change after test $\leq \pm 5$ ppm. Resonance resistance change after test ≤ 5 ohms.	Spending 1000 hrs at 125°C±3°C constant temperature. Measurement taken after DUT being left at room temperature for 24±2 hours.
4.5	Vibration	Frequency change after test $\leq \pm 5$ ppm. Resonance resistance change after test ≤ 5 ohms.	Apply 1.52mm vibration at sweep frequency 10~2000Hz, 5g's for 20min 12 cycles in each direction of 3 axis. Measurement taken after 1 hour.
4.6	Mechanical Shock	Frequency change after test $\leq \pm 5$ ppm. Resonance resistance change after test ≤ 5 ohms. and exhibit no visible damage.	Peak 100gal, normal width 6ms half sine wave form, 3.7m/s, 3 cycles / direction. Measurement taken after 1 hour.
4.7	Solderability	Terminals shall be covered more then 95% with solder.	Passed through the re-flow oven under the following condition. Preheat 150 to 180°C for 60 to 120sec, and soldering time for 20s ± 5s at 235°C, peak soldering time for 5s ±0.5s between 240 and 250°C. There is no need to do functional test. 8-12X magnifier.
4.8	Terminal Strength	No visible damage	Mount on a glass-epoxy board (100x50x1.6mm), then bend to 2mm displacement (velocity 1mm/sec) and keep for 5 seconds. or pulling force 1.8kg for at least 60 seconds.
4.9	Resistance to Soldering Heat	Frequency change after test $\leq \pm 5$ ppm. Resonance resistance change after test ≤ 5 ohms.	Passed through the re-flow oven under the following condition. Preheat 150 to 180°C for 60 to 120sec, and soldering time for 60s max at 235°C, peak soldering time for 10s max at 265°C max. Measurement taken after DUT being left at room temperature for at least 2 hours.
4.10	OTHERS		

5. Recommended Reflow soldering condition (SMD)

Solder profile

Peak: $260 \pm 5^{\circ}\text{C}$ Soldering zone: 230°C or more, $30 \pm 10\text{s}$. Pre-heating zone 1: $150 \sim 180^{\circ}\text{C}$, $90 \pm 30\text{s}$

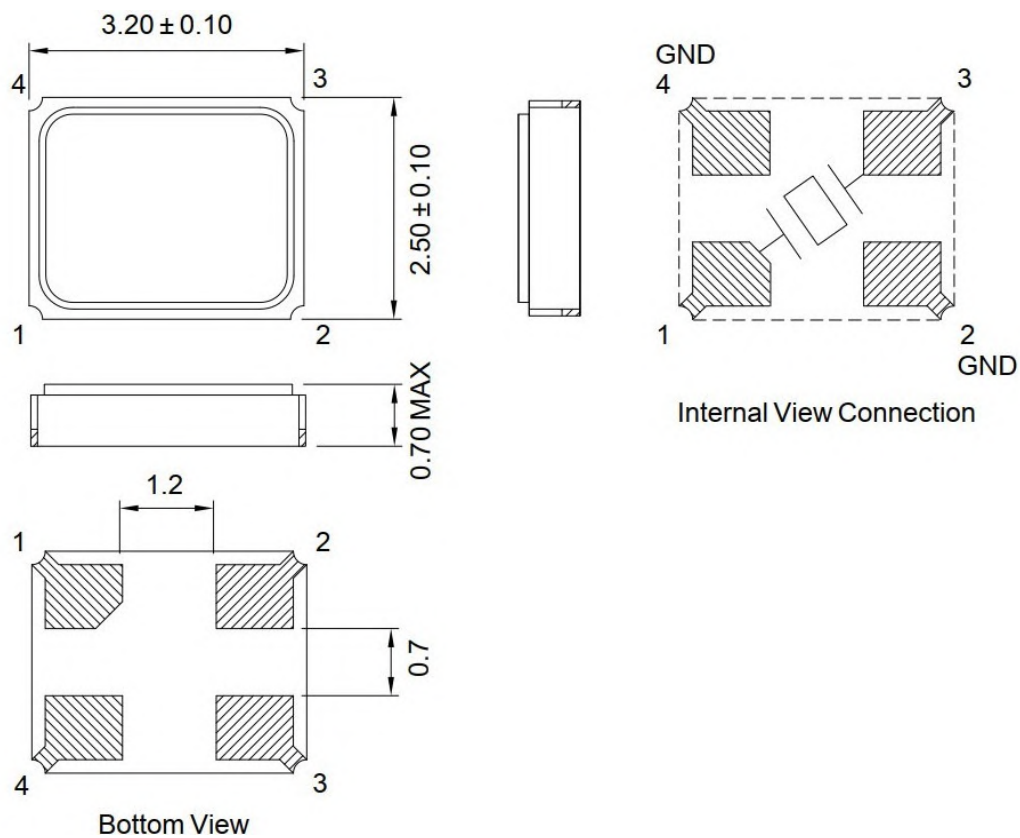


Temperature profile for reflow soldering

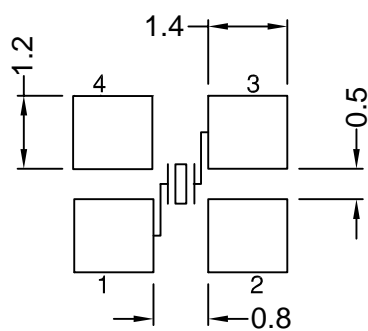
6. Soldering iron method

Bit temperature: $350 \pm 10^{\circ}\text{C}$ Application time of soldering iron: $3 \pm 1\text{ s}$. For other procedures, refer to IEC 60068-2-20.

Package Outline Dimensions

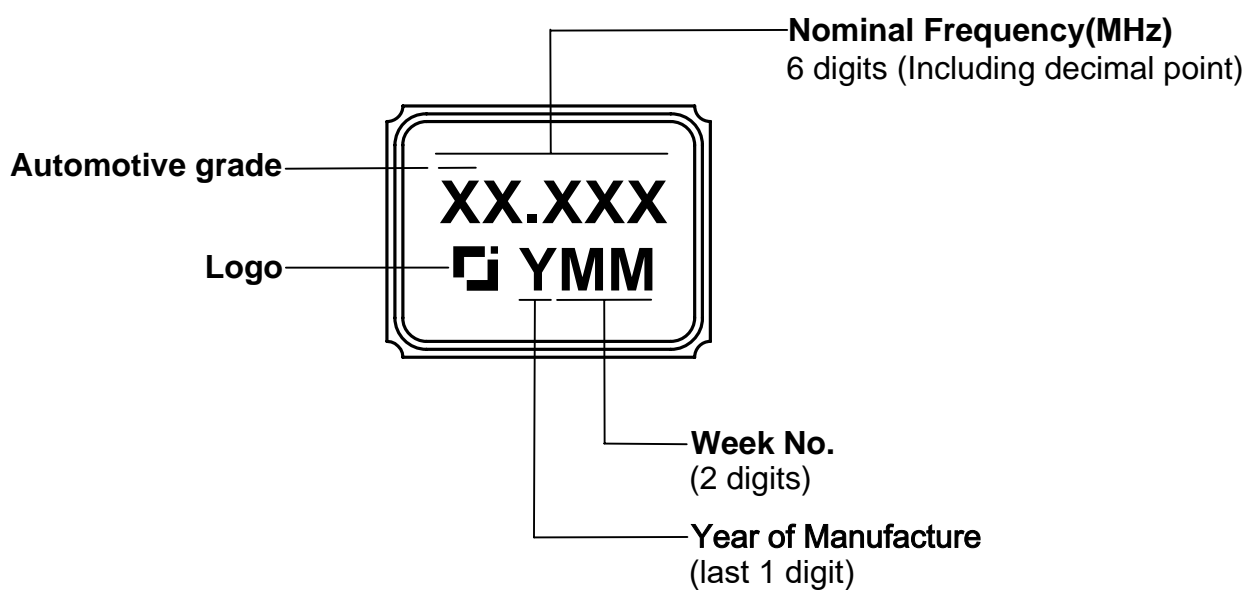


Suggested Pad Layout

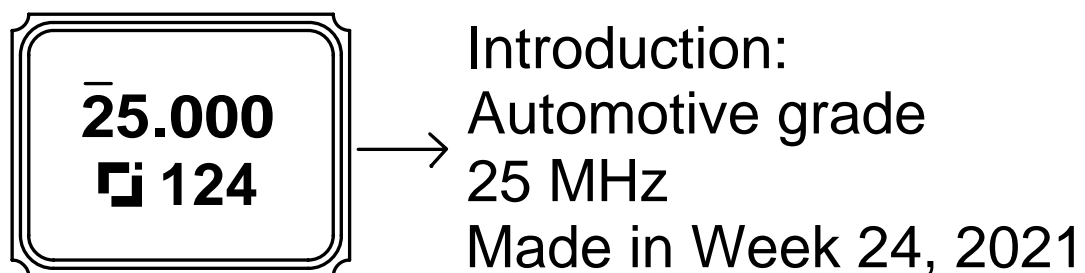


Marking

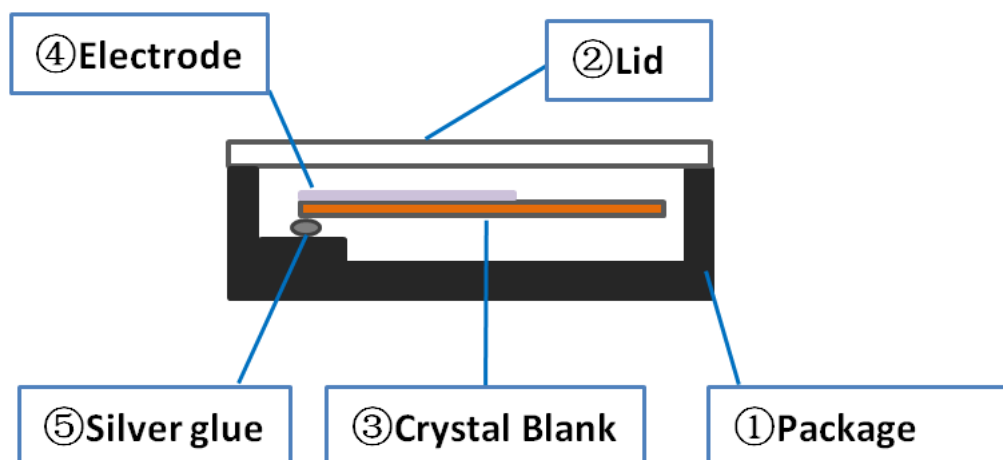
Procedure: Laser



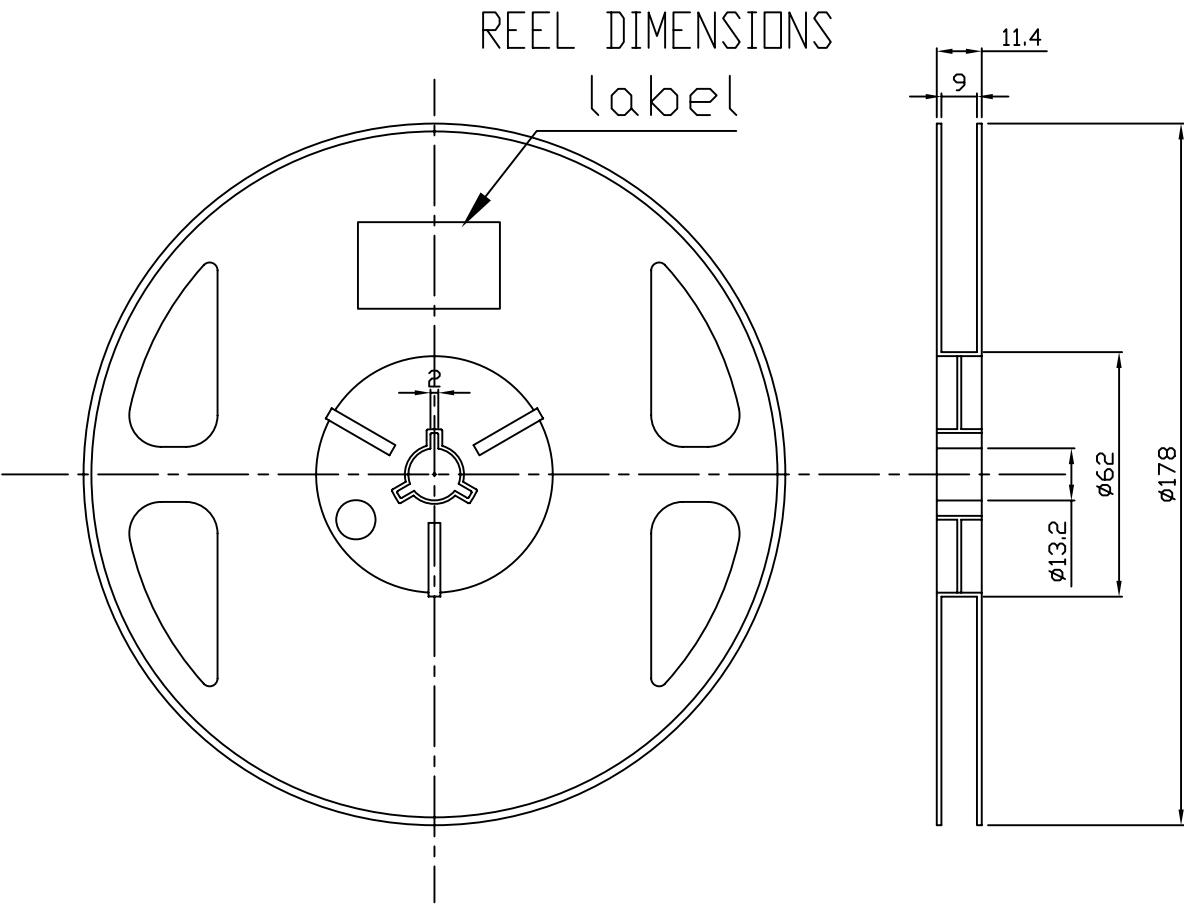
For example:



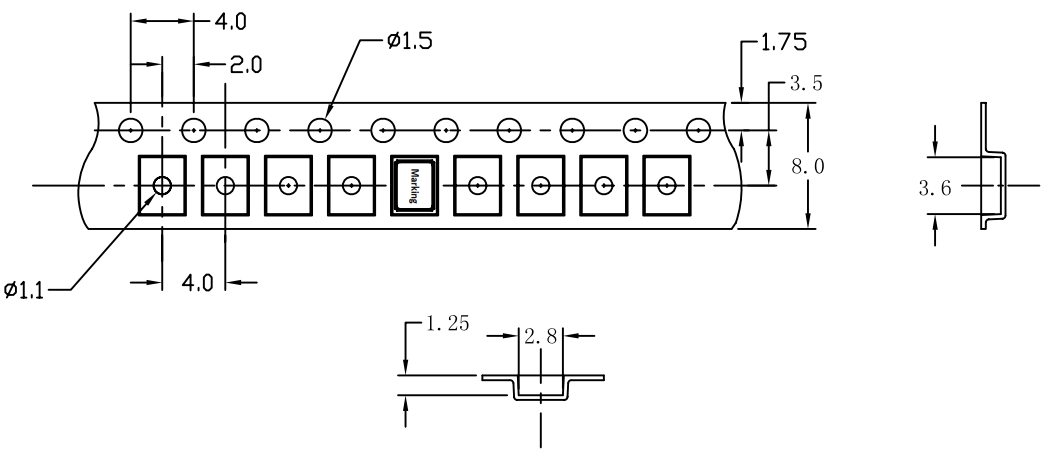
Inside Structure



No.	Components	Materials
1	Package	Ceramic(Al_2O_3)
2	Lid	KV(Fe/Ni/Co)
3	Crystal blank	SiO_2
4	Electrode	Ag, Cr
5	Silver glue	Ag, CH_3OH , SiO_2



EMBOSED TYPE DIMENSIONS

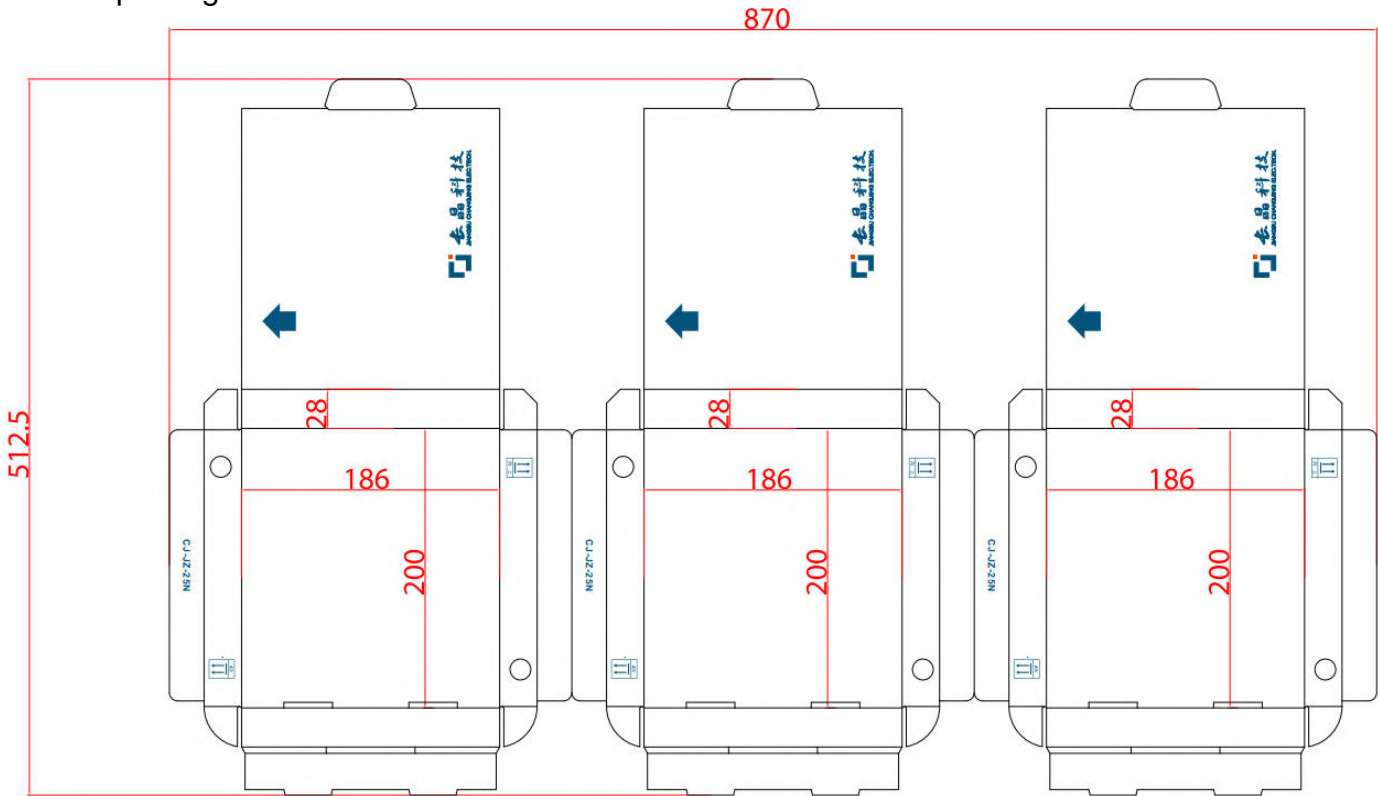


USER FEED DIRECTION

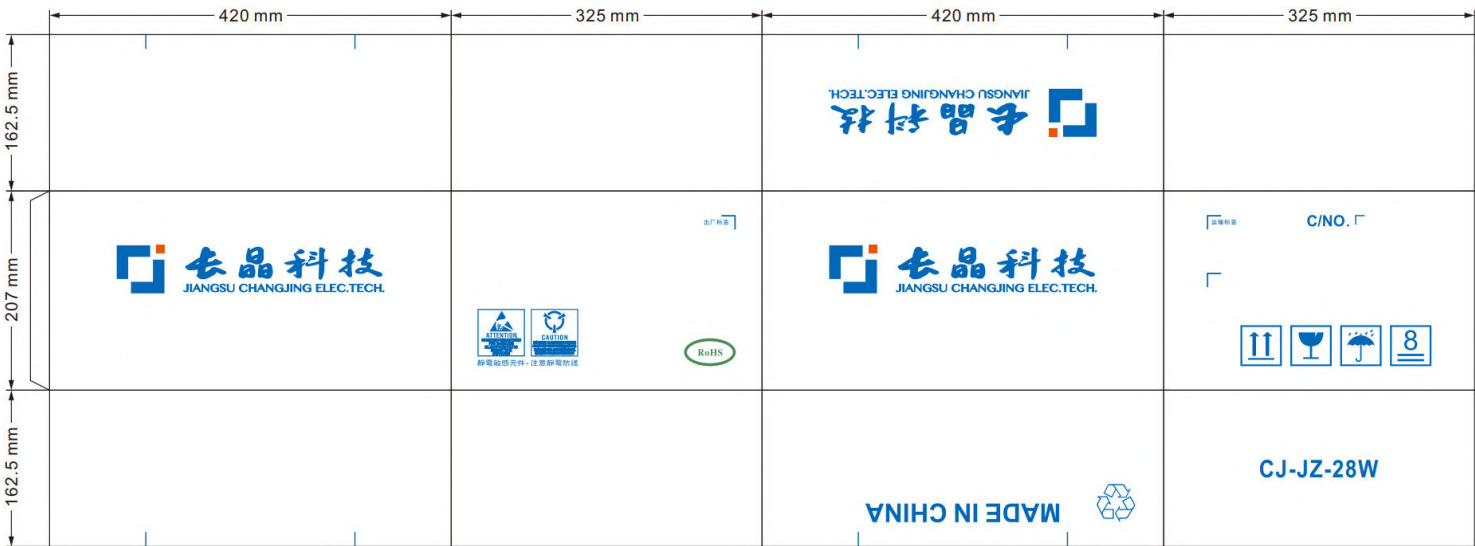
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Package

Inside package



Outside package



NOTICE

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